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**In the Claims**

Claims 1-67 (canceled).

Claim 68 (previously presented): A semiconductor fabrication apparatus, comprising:  
a plurality of lamps positioned proximate a substrate; and  
a plurality of reflectors associated with the lamps, individual ones of the reflectors being associated with individual ones of the lamps, and having a rugged reflective surface.

Claim 69 (previously presented): The apparatus of claim 68 wherein the lamps are positioned between the substrate and the reflectors, the rugged reflective surface of the reflectors facing the lamps and being concave.

Claim 70 (previously presented): The apparatus of claim 68 wherein the lamps are positioned between the substrate and the reflectors, the surface of the reflectors complimenting the surface of the lamps.

Claim 71 (previously presented): The apparatus of claim 70 wherein the lamps have a convex surface and the reflectors have a concave surface.

Claim 72 (previously presented): The apparatus of claim 68 wherein the rugged reflective surface of the reflectors comprises a repeating pattern.

Claim 73 (cancel)

Claim 74 (previously presented): The apparatus of claim 68 wherein the rugged reflective surface of the reflectors comprises a honeycomb pattern.

Claim 75 (previously presented): The apparatus of claim 68 including at least four lamps associated with at least four reflectors.

Claim 76 (previously presented): The apparatus of claim 68 wherein the plurality of lamps are positioned on opposing sides of the substrate.

Claim 77 (previously presented): The apparatus of claim 76 wherein one opposing side of the substrate is supported by a susceptor and a portion of the plurality of lamps is positioned between the susceptor and a portion of the plurality of reflectors.

Claim 78 (previously presented): The apparatus of claim 68 wherein the plurality of lamps are comprised by both outer and inner lamps.